

Vishay General Semiconductor

High-Voltage Schottky Rectifier

High Barrier Technology for Improved High Temperature Performance



PRIMARY CHARACTERISTICS			
I _{F(AV)}	3.0 A		
V _{RRM}	90 V, 100 V		
I _{FSM}	100 A		
V _F	0.65 V		
I _R	20 μΑ		
T _J max.	175 °C		

FEATURES

- Guardring for overvoltage protection
- · Low power losses and high efficiency
- · Low forward voltage drop
- Low leakage current
- High forward surge capability
- High frequency operation
- Solder dip 260 °C, 40 s
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in middle voltage high frequency inverters, freewheeling, dc-to-dc converters, and polarity protection applications.

MECHANICAL DATA

Case: DO-201AD

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC Q101 qualified), meets JESD 201 class 2

whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	SB3H90	SB3H100	UNIT	
Maximum repetitive peak reverse voltage	V _{RRM}	90	100	V	
Maximum working reverse voltage	V_{RWM}	V _{RWM} 90		V	
Maximum DC blocking voltage	V _{DC}	90	100	V	
Maximum average forward rectified current at T _L = 90 °C	I _{F(AV)}	3.0		Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	100		А	
Peak repetitive reverse surge current at $t_p = 2.0 \mu s$, 1 kHz	I _{RRM}	1.0		Α	
Critical rate of rise of reverse voltage	dV/dt	10 000		V/μs	
Storage temperature range	T _{STG}	- 55 to + 175		°C	
Maximum operating junction temperature	T _J	175		°C	

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CO	ONDITIONS	SYMBOL	SB3H90	SB3H100	UNIT
Maximum instantaneous forward voltage ⁽¹⁾	I _F = 3.0 A I _F = 3.0 A	T _J = 25 °C T _J = 125 °C	V_{F}	0.i 0.i		V
Maximum reverse current at rated V _R ⁽²⁾		$T_J = 25 ^{\circ}\text{C}$ $T_J = 125 ^{\circ}\text{C}$	I _R	20 4.0		μA mA

Notes:

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

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THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	R SYMBOL SB3H90 SB3H100		UNIT	
Maximum thermal resistance (1)	$egin{aligned} R_{ hetaJA}\ R_{ hetaJL} \end{aligned}$	50 20		°C/W

Note:

(1) P.C.B. mounted with 0.2 x 0.2" (5.0 x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
SB3H100-E3/54	1.09	54	1400	13" diameter paper tape and reel		
SB3H100-E3/73	1.09	73	1000	Ammo pack packaging		
SB3H100HE3/54 ⁽¹⁾	1.09	54	1400	13" diameter paper tape and reel		
SB3H100HE3/73 ⁽¹⁾	1.09	73	1000	Ammo pack packaging		

Note:

(1) Automotive grade AEC Q101 qualified

RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

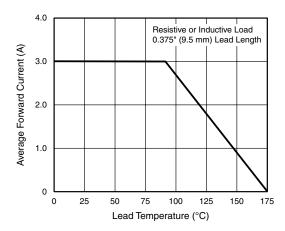


Figure 1. Forward Current Derating Curve

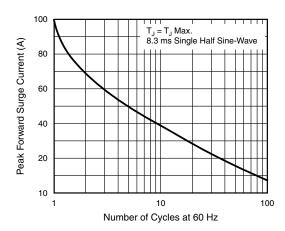


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

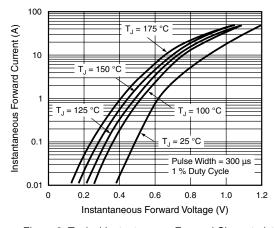


Figure 3. Typical Instantaneous Forward Characteristics

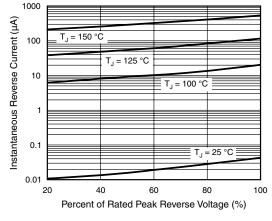


Figure 4. Typical Reverse Characteristics



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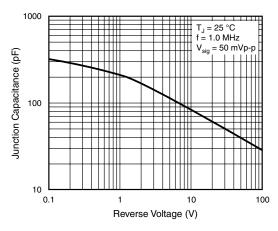


Figure 5. Typical Junction Capacitance

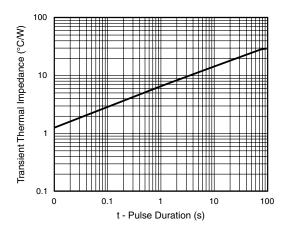
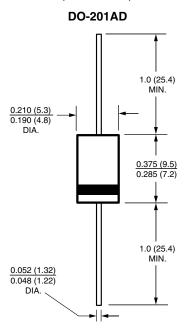


Figure 6. Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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